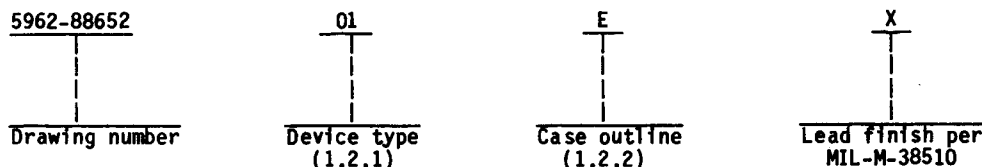


1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices".

1.2 Part number. The complete part number shall be as shown in the following example:



1.2.1 Device types. The device types shall identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	54FCT182	High speed carry lookahead generator
02	54FCT182A	High speed carry lookahead generator

1.2.2 Case outlines. The case outlines shall be as designated in appendix C of MIL-M-38510, and as follows:

<u>Outline letter</u>	<u>Case outline</u>
E	D-2 (16-lead, .840" x .310" x .200"), dual-in-line package
F	F-5 (16-lead, .440" x .285" x .085"), flat package
2	C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package

1.3 Absolute maximum ratings. 1/

Supply voltage range	-0.5 V dc to +6.0 V dc
Input voltage range	-0.5 V dc to $V_{CC} + 0.5$ V dc
Output voltage range	-0.5 V dc to $V_{CC} + 0.5$ V dc
DC input diode current (I_{IK})	-20 mA
DC output diode current (I_{OK})	-50 mA
DC output current	± 100 mA
Maximum power dissipation (P_D) 2/-	500 mW
Thermal resistance, junction-to-case (θ_{JC})	See MIL-M-38510, appendix C
Storage temperature range	-65°C to +150°C
Junction temperature (T_J)	+175°C
Lead temperature (soldering, 10 seconds)	+300°C

1.4 Recommended operating conditions.

Supply voltage range (V_{CC})	- - - - -	+4.5 V dc to +5.5 V dc
Maximum low level input voltage (V_{IL})	- - - - -	0.8 V dc
Minimum high level input voltage (V_{IH})	- - - - -	2.0 V dc
Case operating temperature (T_C)	- - - - -	-55°C to +125°C

1/ All voltages referenced to GND.

2/ Must withstand the added P_D due to short circuit test; e.g., I_{OS} .

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2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth table. The truth table shall be as specified on figure 2.

3.2.3 Logic diagram. The logic diagram shall be as specified on figure 3.

3.2.4 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein

3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

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TABLE 1. Electrical performance characteristics.

Test	Symbol	Conditions -55°C < T _C < +125°C V _{CC} = 5.0 V _{dc} ±10% unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
High level output voltage	V _{OH}	V _{CC} = 4.5 V, V _{IL} = 0.8 V, V _{IH} = 2.0 V	I _{OH} = -300 µA	1, 2, 3	A11	4.3	V
			I _{OH} = -12 mA	1, 2, 3	A11	2.4	V
Low level output voltage	V _{OL}	V _{CC} = 4.5 V, V _{IL} = 0.8 V, V _{IH} = 2.0 V	I _{OL} = 300 µA	1, 2, 3	A11	0.2	V
			I _{OL} = 32 mA	1, 2, 3	A11	0.5	V
Input clamp voltage	V _{IK}	V _{CC} = 4.5 V, I _{IN} = -18 mA	1, 2, 3	A11		-1.2	V
High level input current	I _{IH}	V _{CC} = 5.5 V, V _{IN} = 5.5 V	1, 2, 3	A11		5.0	µA
Low level input current	I _{IL}	V _{CC} = 5.5 V, V _{IN} = GND	1, 2, 3	A11		-5.0	µA
Short circuit output current	I _{OS}	V _{CC} = 5.5 V <u>1/</u> , V _{OUT} = 0.0 V	1, 2, 3	A11	-60		mA
Quiescent power supply current (CMOS inputs)	I _{CCQ}	V _{IN} ≤ 0.2 V or V _{IN} > 5.3 V, V _{CC} = 5.5 V, f _I = 0.0 MHz	1, 2, 3	A11		1.5	mA
Power supply current (TTL inputs high)	ΔI _{CC}	V _{CC} = 5.5 V, V _{IN} = 3.4 V <u>2/</u>	1, 2, 3	A11		2.0	mA
Dynamic power supply current	I _{CCD}	V _{CC} = 5.5 V V _{IN} ≥ 5.3 V or V _{IN} ≤ 0.2 V, outputs open, one bit toggling: 50% duty cycle	<u>3/</u>	A11		0.3	mA/ MHz

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T _C < +125°C V _{CC} = 5.0 V _{dc} ±10% unless otherwise specified	Group A subgroups	Device type	Limits		Unit	
					Min	Max		
Total power supply current <u>4/</u>	I _{CC}	V _{IN} ≥ 5.3 V or V _{IN} < 0.2 V, V _{CC} = 5.5 V, f _I = 10 MHz, Outputs open, one bit toggling: 50% duty cycle	1, 2, 3	A11		4.5	mA	
		V _{IN} = 3.4 V or V _{IN} = GND, V _{CC} = 5.5 V, f _I = 10 MHz, Outputs open, one bit toggling: 50% duty cycle				5.5	mA	
Functional tests		See 4.3.1d	7, 8	A11				
Input capacitance	C _{IN}	See 4.3.1c	4	A11		10	pF	
Output capacitance	C _{OUT}	See 4.3.1c	4	A11		12	pF	
Propagation delay time, C _n to C _n + x, C _n + y, C _n + z	t _{PLH1} , t _{PHL1}	V _{CC} = 5.0 V R _L = 500Ω C _L = 50 pF See figure 4 <u>5/</u>	9, 10, 11	01	2.0	16.5	ns	
				02	2.0	10.7		
Propagation delay time, P ₀ , P ₁ , P ₂ to C _n + x, C _n + y, C _n + z	t _{PLH2} , t _{PHL2}		9,10,11	01	1.5	11.5	ns	
				02	1.5	7.4		
Propagation delay time, G ₀ , G ₁ , G ₂ to C _n + x, C _n + y, C _n + z	t _{PLH3} , t _{PHL3}		9, 10, 11	01	1.5	11.5	ns	
				02	1.5	7.4		
Propagation delay time, P ₁ , P ₂ , P ₃ to G	t _{PLH4} , t _{PHL4}		9, 10, 11	01	2.0	16.5	ns	
				02	2.0	10.7		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions -55°C < T _C < +125°C V _{CC} = 5.0 V _{dc} ±10% unless otherwise specified	Group A subgroups	Device type	Limits		Unit
					Min	Max	
Propagation delay time, G _n to G	t _{PLH5} , t _{PHL5}	V _{CC} = 5.0 V R _L = 500Ω C _L = 50 pF See figure 4 5/	9, 10, 11	01	2.0	16.5	ns
				02	2.0	10.7	
Propagation delay time, P _n to P	t _{PLH6} , t _{PHL6}		9, 10, 11	01	1.5	12.5	ns
				02	1.5	7.4	

1/ Not more than one output should be shorted at one time, and the duration of the short circuit condition should not exceed 1 second.

2/ TTL driven input, V_{IN} = 3.4 V; all other inputs at V_{CC} or GND.

3/ This parameter is not directly testable, but is derived for use in total power supply calculations.

$$4/ I_{CC} = I_{CCQ} + (\Delta I_{CC} \times D_H \times N_I) + (I_{CCD}(f_I \times N_I))$$

where: D_H = Duty cycle for TTL inputs high
N_I = Number of TTL inputs at D_H
f_I = Input frequency in MHz
N_I = Number of inputs at f_I

5/ The minimum limits are guaranteed, if not tested, to the limits specified in table I.

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Device types	01 and 02	
Case outlines	E and F	2
Terminal number	Terminal symbol	Terminal symbol
1	G ₁	NC
2	P ₁	G ₁
3	G ₀	P ₁
4	P ₀	G ₀
5	G ₃	P ₀
6	P ₃	NC
7	GND	G ₃
8	C ₅ + z	P ₃
9	C ₅ + y	P
10	C ₅ + x	GND
11	C ₅	NC
12	C ₅	C _n + z
13	C ₅	G _n
14	P ₂	C _n + y
15	V _{CC}	C _n + x
16	---	NC
17	---	C ₅
18	---	G ₂
19	---	P ₂
20	---	V _{CC}

NC = No connection

FIGURE 1. Terminal connections.

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Definition of functional terms

Pin names	Description
C_n	Carry input
$\overline{G}_0, \overline{G}_2$	Carry generate inputs (active low)
\overline{G}_1	Carry generate input (active low)
\overline{G}_3	Carry generate input (active low)
$\overline{P}_0, \overline{P}_1$	Carry propagate inputs (active low)
\overline{P}_2	Carry propagate input (active low)
\overline{P}_3	Carry propagate input (active low)
$C_n + x - C_n + z$	Carry outputs
\overline{G}	Carry generate output (active low)
\overline{P}	Carry propagate output (active low)

FIGURE 1. Terminal connections - Continued.

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Inputs										Outputs				
C_n	\overline{G}_0	\overline{P}_0	\overline{G}_1	\overline{P}_1	\overline{G}_2	\overline{P}_2	\overline{G}_3	\overline{P}_3		$C_n + x$	$C_n + y$	$C_n + z$	\overline{G}	\overline{P}
X	H	H								L				
L	H	X								L				
X	L	X								H				
H	X	L								H				
X	X	X	H	H							L			
X	H	H	H	X							L			
L	H	X	H	X							L			
X	X	X	L	X							H			
X	L	X	X	L							H			
H	X	L	X	L							H			
X	X	X	X	X	H	H						L		
X	X	X	H	H	H	X						L		
X	H	H	H	X	H	X						L		
L	H	X	H	X	H	X						L		
X	X	X	X	X	L	X						H		
X	X	X	L	X	X	L						H		
X	L	X	X	L	X	L						H		
H	X	L	X	L	X	L						H		
X		X	X	X	X	H	H						H	
X		X	X	H	H	X	H	X					H	
X		H	X	H	X	H	X	X					H	
X		X	X	X	X	L	X	L					L	
X		X	X	X	L	X	X	L					L	
L		X	L	X	L	X	X	L					L	
	H		X		X		X							H
	X		H		X		X							H
	X		X		H		X							H
	X		X		X		X							H
	L		L		L		L							L

H = High voltage level
L = Low voltage level
X = Irrelevant

FIGURE 2. Truth table.

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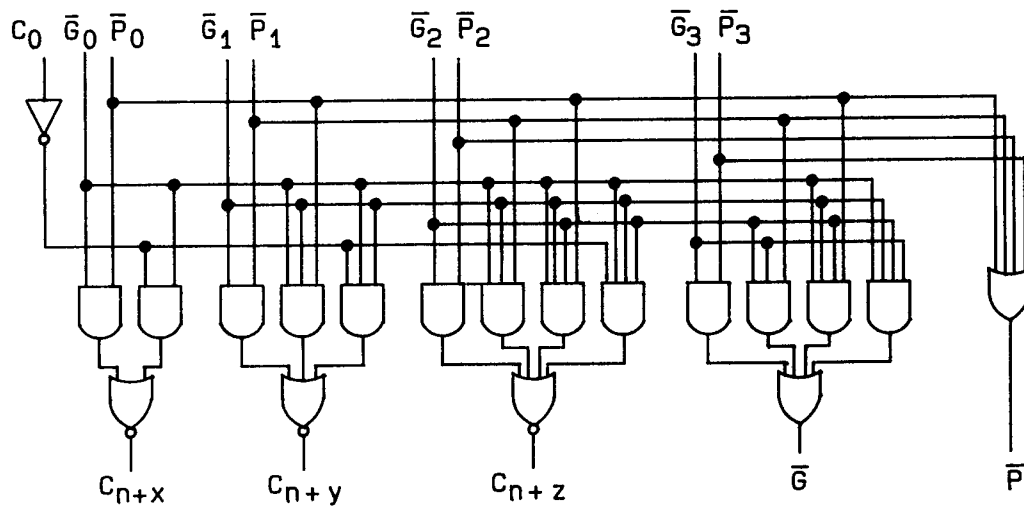
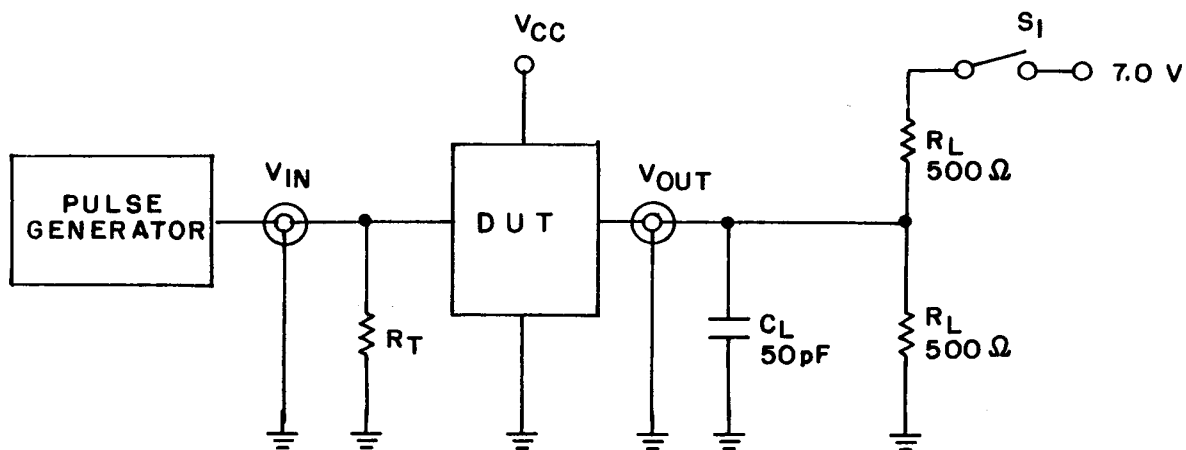


FIGURE 3. Logic diagram.

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NOTES:

1. Pulse generator for all pulses: $PRR \leq 1.0 \text{ MHz}$; $Z_{OUT} \leq 50 \Omega$;
 $t_r = t_f \leq 2.5 \text{ ns}$.
2. Switch S_1 is open.
3. C_L includes probe and jig capacitance.
4. R_T = Termination resistance should be equal to Z_{OUT} of the pulse generator.

FIGURE 4. Test circuit and switching waveforms.

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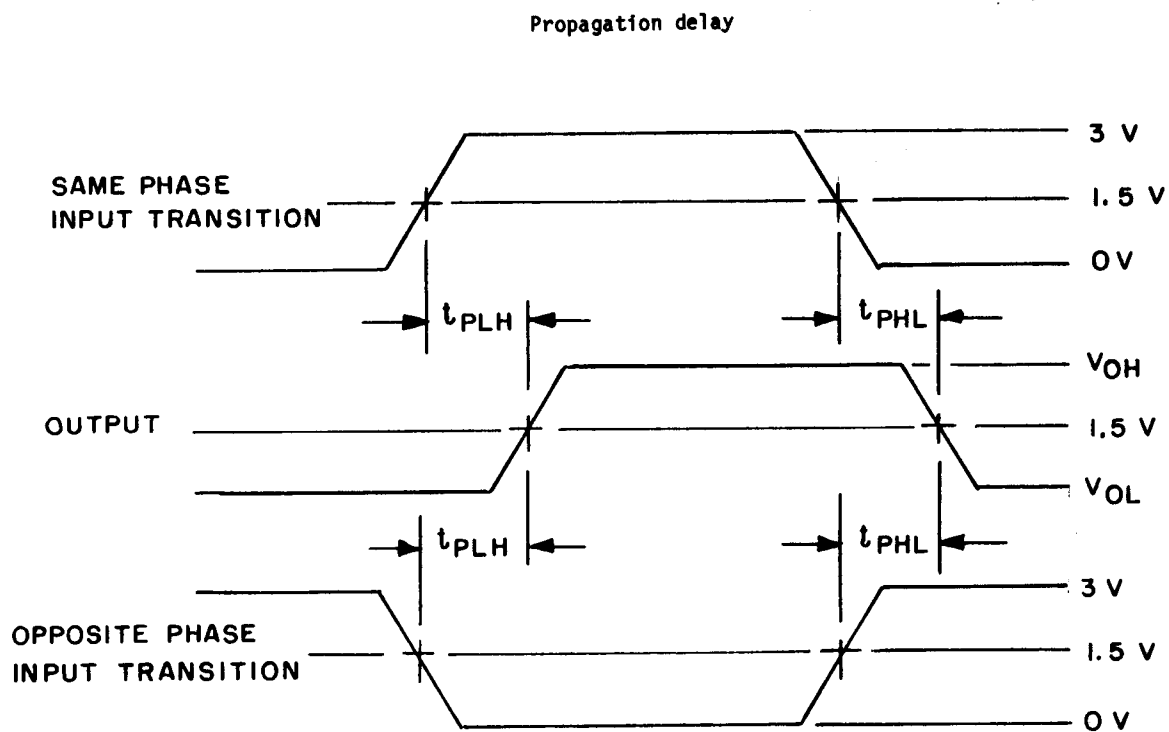


FIGURE 4. Test circuit and switching waveforms - Continued.

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3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroup 4 (C_{IN} and C_{OUT} measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on five devices with zero failures.

d. Subgroups 7 and 8 tests shall verify the truth table as specified on figure 2 herein.

4.3.2 Groups C and D inspections.

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test conditions, method 1005 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

(3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

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TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*,2,3,7,8,9, 10,11
Group A test requirements (method 5005)	1,2,3,4,7,8,9, 10,11
Groups C and D end-point electrical parameters (method 5005)	1,2,3

* PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

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6.4 Approved source of supply. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number <u>1/</u>
5962-8865201EX	61772	IDT54FCT182DB
5962-8865201FX	61772	IDT54FCT182EB
5962-88652012X	61772	IDT54FCT182LB
5962-8865202EX	61772	IDT54FCT182ADB
5962-8865202FX	61772	IDT54FCT182AEB
5962-88652022X	61772	IDT54FCT182ALB

1/ Caution. Do not use this number for item acquisition.
Items acquired by this number may not satisfy the
performance requirements of this drawing.

Vendor CAGE
number

61772

Vendor name
and address

Integrated Device Technology
3236 Scott Boulevard
Santa Clara, CA 95052

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